



GENERAL DESCRIPTION



The ICS840004-11 is a 4 output LVCMOS/LVTTL Synthesizer optimized to generate Ethernet reference clock frequencies and is a member of the HiPerClocks™ family of high performance clock solutions from ICS. Using a 25MHz, 18pF parallel resonant crystal, 125MHz and 62.5MHz can be generated based on one frequency select pin (F_SEL). The ICS840004-11 uses ICS' 3rd generation low phase noise VCO technology and can achieve 1ps or lower typical random rms phase jitter, easily meeting Ethernet jitter requirements. The ICS840004-11 is packaged in a small 20-pin TSSOP package.

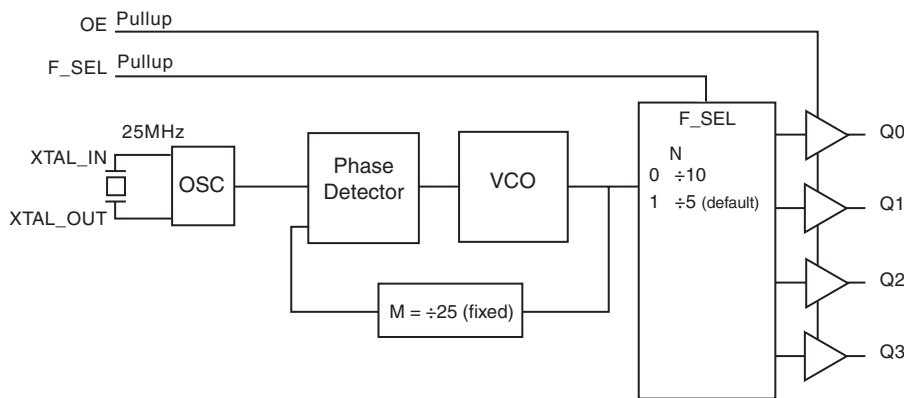
FEATURES

- Four LVCMOS/LVTTL outputs, 17Ω typical output impedance
 - Crystal oscillator interface
 - Input frequency range: 22.4MHz to 28MHz
 - Output frequency Range: 56MHz - 140MHz
 - VCO Range: 560MHz - 700MHz
 - RMS phase jitter at 125MHz (1.875MHz - 20MHz): 0.70ps (typical)
- Phase noise:
- | Offset | Noise Power |
|--------------|---------------|
| 100Hz | -95.5 dBc/Hz |
| 1kHz | -123.6 dBc/Hz |
| 10kHz | -132.8 dBc/Hz |
| 100kHz | -133.4 dBc/Hz |
- Full 3.3V supply
 - 0°C to 70°C ambient operating temperature
 - Available in both standard and lead-free RoHS-compliant packages

FREQUENCY SELECT FUNCTION TABLE FOR ETHERNET FREQUENCIES

Inputs			Output Frequency (MHz) (25MHz Ref.)
F_SEL	M Divider Value	N Divider Value	
0	25	10	62.5
1	25	5	125 (default)

BLOCK DIAGRAM



PIN ASSIGNMENT

F_SEL	1	20	nc
nc	2	19	GND
nc	3	18	Q0
nc	4	17	Q1
OE	5	16	VDDO
nc	6	15	Q2
nc	7	14	Q3
VDDA	8	13	GND
nc	9	12	XTAL_IN
VDD	10	11	XTAL_OUT

ICS840004-11 20-Lead TSSOP

6.5mm x 4.4mm x 0.92mm
package body
G Package
Top View



TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	F_SEL	Input	Pullup	Frequency select pin. LVCMOS/LVTTL interface levels.
2, 3, 4, 6, 7, 9, 20	nc	Unused		No connect.
5	OE	Input	Pullup	Output enable pin. When HIGH, the outputs are active. When LOW, the outputs are in a high impedance state. LVCMOS/LVTTL interface levels.
8	V _{DDA}	Power		Analog supply pin.
10	V _{DD}	Power		Core supply pin.
11, 12	XTAL_OUT, XTAL_IN	Input		Crystal oscillator interface. XTAL_OUT is the output. XTAL_IN is the input.
13, 19	GND	Power		Power supply ground.
14, 15 17, 18	Q3, Q2, Q1, Q0	Output		Single-ended clock outputs. LVCMOS/LVTTL interface levels. 17Ω typical output impedance.
16	V _{DDO}	Power		Output supply pin.

NOTE: *Pullup* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
C _{PD}	Power Dissipation Capacitance	V _{DD} , V _{DDA} , V _{DDO} = 3.465V		8		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{OUT}	Output Impedance			17		Ω



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_i	-0.5V to $V_{DD} + 0.5V$
Outputs, V_o	-0.5V to $V_{DDO} + 0.5V$
Package Thermal Impedance, θ_{JA}	73.2°C/W (0 lfm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 3A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDA}	Analog Supply Voltage		3.135	3.3	3.465	V
V_{DDO}	Output Supply Voltage		3.135	3.3	3.465	V
I_{DD}	Power Supply Current				100	mA
I_{DDA}	Analog Supply Current				12	mA
I_{DDO}	Output Supply Current	No Load			10	mA

TABLE 3B. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		2		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage		-0.3		0.8	V
I_{IH}	Input High Current	OE, F_SEL $V_{DD} = V_{IN} = 3.465V$			5	μA
I_{IL}	Input Low Current	OE, F_SEL $V_{DD} = 3.465V, V_{IN} = 0V$	-150			μA
V_{OH}	Output High Voltage; NOTE 1	$V_{DDO} = 3.3V \pm 5\%$	2.6			V
V_{OL}	Output Low Voltage; NOTE 1	$V_{DDO} = 3.3V \pm 5\%$			0.5	V

NOTE 1: Outputs terminated with 50Ω to $V_{DDO}/2$. See Parameter Measurement Information, 3.3V Output Load Test Circuit.

TABLE 4. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency			25		MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

NOTE: Characterized using an 18pF parallel resonant crystal.



TABLE 5A. AC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{OUT}	Output Frequency Range	F_SEL = 1	112		140	MHz
		F_SEL = 0	56		70	MHz
t _{sk(o)}	Output Skew; NOTE 1, 2				80	ps
t _{jit(Ø)}	RMS Phase Jitter (Random); NOTE 3	125MHz @ Integration Range: 1.875MHz - 20MHz		0.70		ps
		62.5MHz @ Integration Range: 1.875MHz - 20MHz		0.54		ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	200		700	ps
odc	Output Duty Cycle	F_SEL = 0	48		52	%
		F_SEL = 1	46		54	%

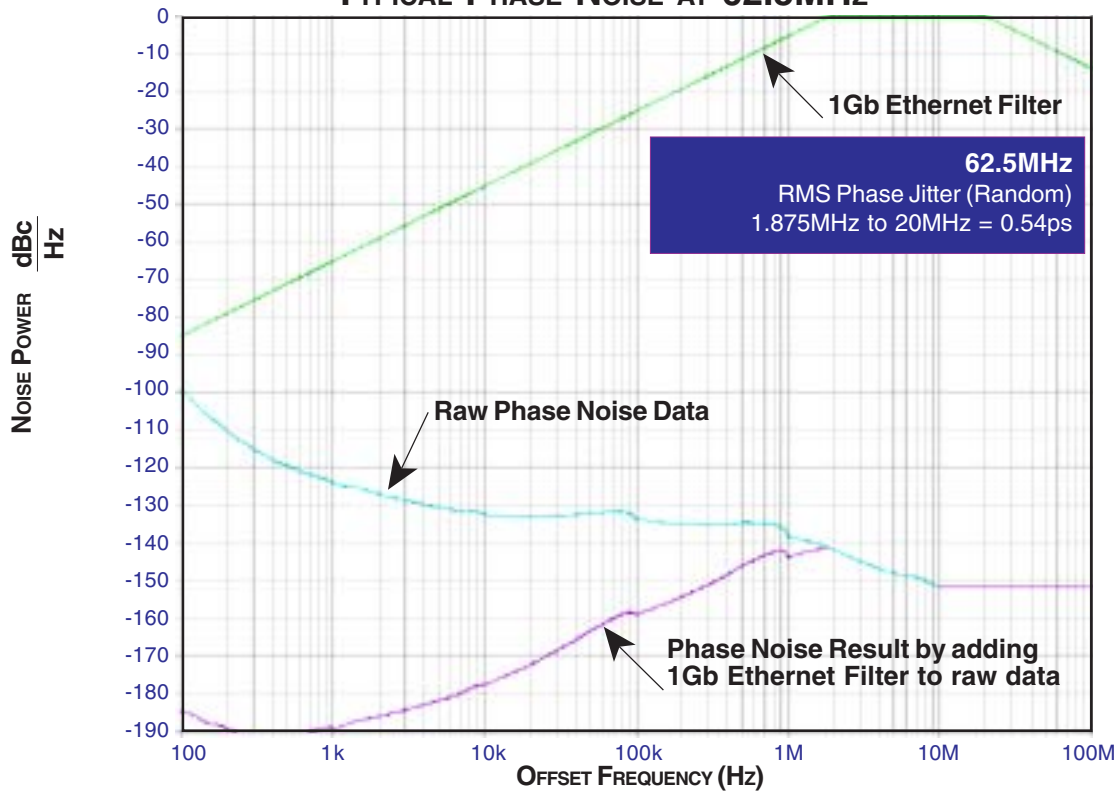
NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions.
Measured at $V_{DDO}/2$.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

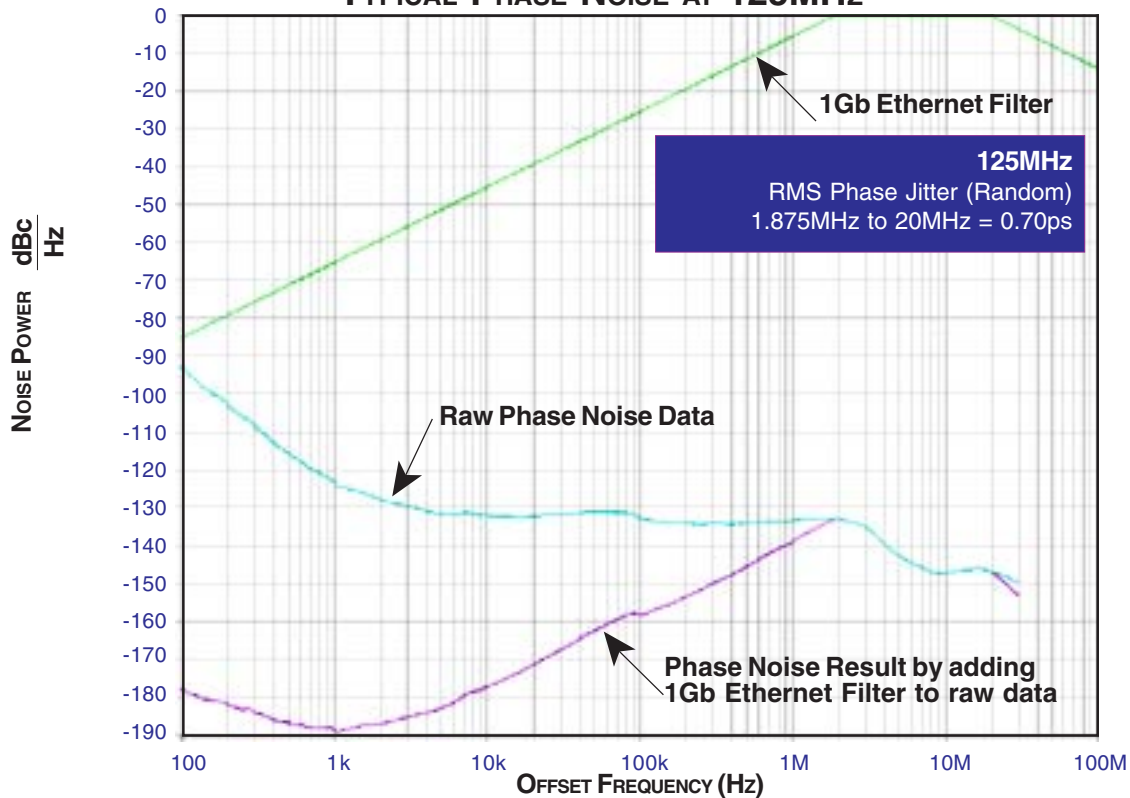
NOTE 3: Please refer to the Phase Noise Plot.



TYPICAL PHASE NOISE AT 62.5MHz

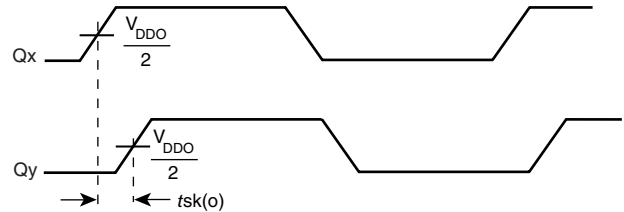
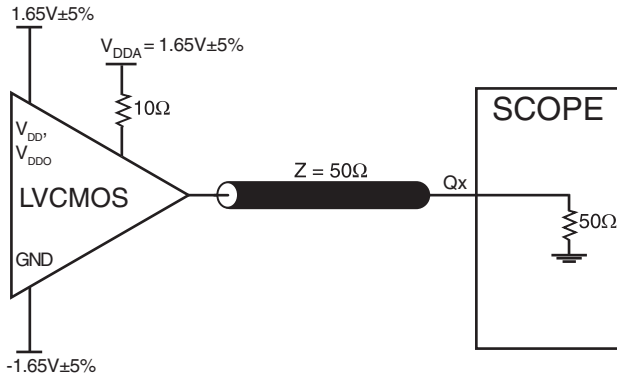


TYPICAL PHASE NOISE AT 125MHz



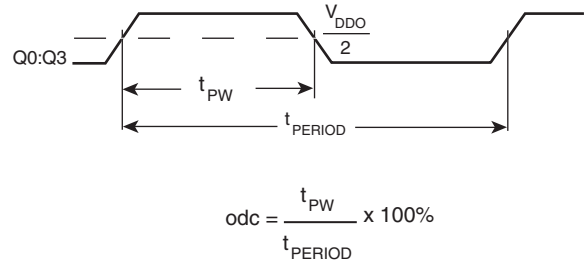
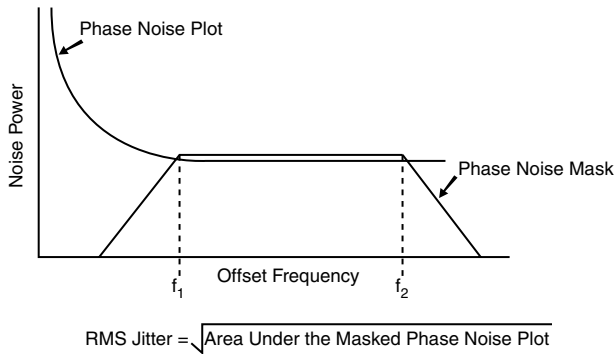


PARAMETER MEASUREMENT INFORMATION



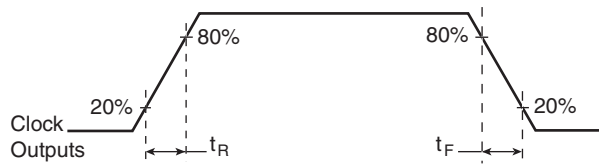
3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT

OUTPUT SKEW



RMS PHASE JITTER

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



OUTPUT RISE/FALL TIME



APPLICATION INFORMATION

POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS840004-11 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{DD} , V_{DDA} and V_{DDO} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 1* illustrates how a 10Ω resistor along with a $10\mu\text{F}$ and a $.01\mu\text{F}$ bypass capacitor should be connected to each V_{DDA} .

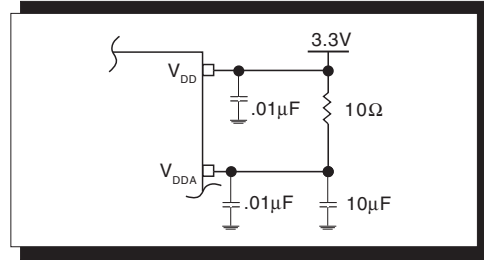


FIGURE 1. POWER SUPPLY FILTERING

CRYSTAL INPUT INTERFACE

The ICS840004-11 has been characterized with 18pF parallel resonant crystals. The capacitor values shown in *Figure 2*

below were determined using a 25MHz, 18pF parallel resonant crystal and were chosen to minimize the ppm error.

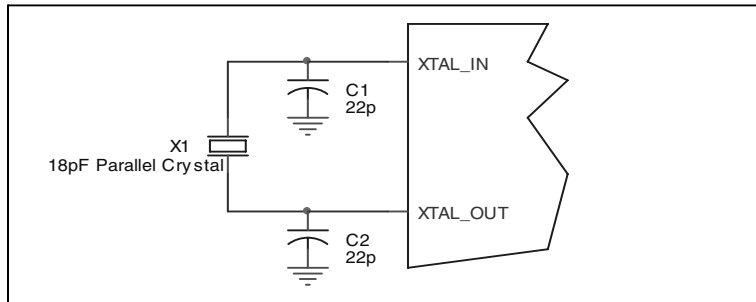


Figure 2. CRYSTAL INPUT INTERFACE

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A $1\text{k}\Omega$ resistor can be used.

OUTPUTS:

LVCMOS OUTPUT:

All unused LVCMOS output can be left floating. We recommend that there is no trace attached.



RELIABILITY INFORMATION

TABLE 6. θ_{JA} vs. AIR FLOW TABLE FOR 20 LEAD TSSOP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS840004-11 is: 1795



PACKAGE OUTLINE - G SUFFIX FOR 20 LEAD TSSOP

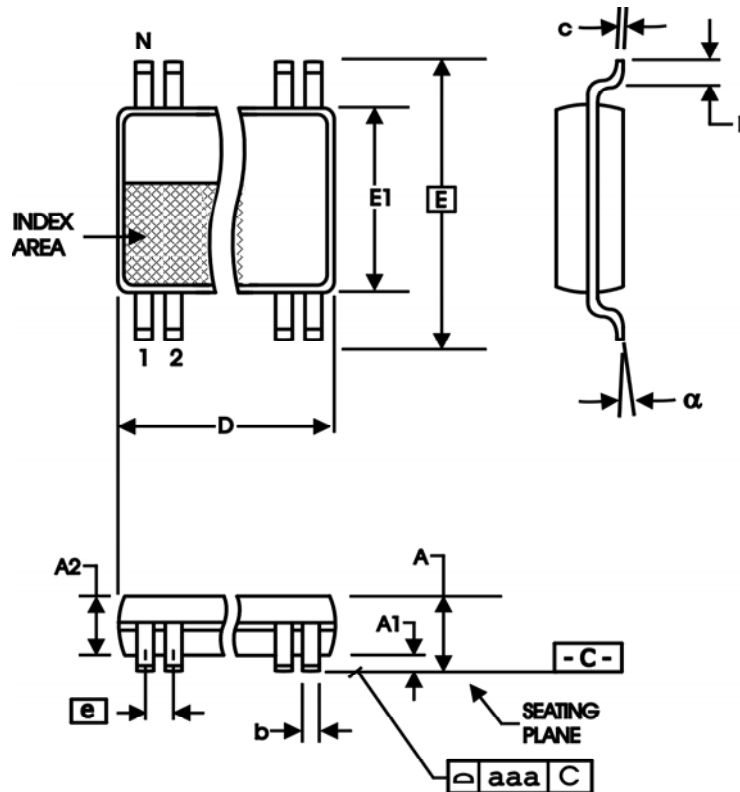


TABLE 7. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	MIN	MAX
N	20	
A	--	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	6.40	6.60
E	6.40 BASIC	
E1	4.30	4.50
e	0.65 BASIC	
L	0.45	0.75
alpha	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-153



Integrated
Circuit
Systems, Inc.

ICS840004-11

FEMTOCLOCKS™ CRYSTAL-TO- LVCMOS/LVTTL FREQUENCY SYNTHESIZER

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS840004AG-11	ICS840004A11	20 Lead TSSOP	tube	0°C to 70°C
ICS840004AG-11T	ICS840004A11	20 Lead TSSOP	2500 tape & reel	0°C to 70°C
ICS840004AG-11LF	ICS40004A11L	20 Lead "Lead-Free" TSSOP	tube	0°C to 70°C
ICS840004AG-11LFT	ICS40004A11L	20 Lead "Lead-Free" TSSOP	2500 tape & reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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